

## Analysis of Surface and Interfacial Reactions in Ultra-thin Al<sub>2</sub>O<sub>3</sub>/SiO<sub>2</sub>/Si films by SR XPS

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### Introduction

Al<sub>2</sub>O<sub>3</sub> is one of the prominent materials in various applications such as catalysis, coating, and microelectronics. Especially, in microelectronics it has been considered as one of the candidates for next generation high-*k* dielectrics in CMOS gate electrodes and metal-insulator-metal (MIM) electron emitter devices. In nano-scale film growth, analysis of interfacial reactions between substrate and film are important in considering the device abilities. SR-XPS has advantages in analyzing the chemical states changes and elemental bonding at interface due to its energy variability with ultra-brilliant. In the present work, ultra-thin Al<sub>2</sub>O<sub>3</sub> films with thickness ranging from 2-10 nm were deposited on SiO<sub>2</sub>/Si substrate and their interfacial analysis was carried out.

### Experimental

The experiment was carried out at KEK-PF BL-13C. Samples used were Al<sub>2</sub>O<sub>3</sub> films with thickness 2, 3, 4.5, 10 nm deposited on SiO<sub>2</sub>/Si (100) n-type substrate with thickness 525 μm. XPS spectra were obtained using the SR excitation energy from 130-1000 eV with CMA analyzer PHI model 1600C. The analyzer was set normal to sample while the excitation beam was set at 55°. Analysis area was 800 μm with solid angle ±7°. The system based pressure during measurement was 2.8 × 10<sup>-8</sup> Pa.

### Results and discussion

Fig. 1 shows the XPS spectra obtained in 3 nm Al<sub>2</sub>O<sub>3</sub> film thickness with X-ray excitation energy 730 eV and 1000 eV. The depth of excited photoelectrons showed different characters according to variations in excitation energy.

Photoelectron peaks penetrated from Al<sub>2</sub>O<sub>3</sub>, substrate Si and interfacial layer SiO<sub>2</sub> were observed. In 730 eV, Al<sub>2</sub>O<sub>3</sub> photoelectron peak appeared strongly. Energy loss appeared as surface Plasmon peak at higher binding energy around 14 eV from main peak. Si2p photoelectron peak together with SiO<sub>2</sub> peak, Al2s and Si2p peaks were also observed. In 1000 eV where the excitation energy was large, the penetrated photoelectrons peaks showed much prominent from SiO<sub>2</sub>/Si substrate and no Plasmon like peaks were observed.

The other samples with different film thickness were also measured and showed different interfacial characteristic according to the different excitation energy and details of interfacial mechanism will be analyzed further.

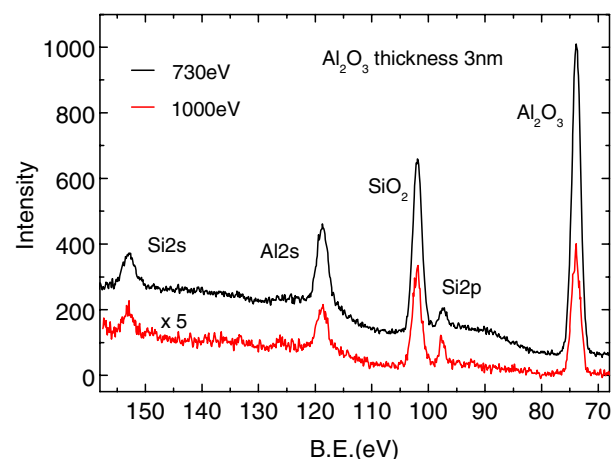


Fig. 1 XPS spectra of Al<sub>2</sub>O<sub>3</sub>/SiO<sub>2</sub>/Si sample with different excitation energies